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SE050 configurations

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Application note

Revision history

Revision history

Revision number	Date	Description
1.2	2020-02-27	added Section 2.6.1
1.1	2019-11-27	updated Table 3
1.0	2019-10-11	Initial release

Abbreviations

Abbreviations

Acronym	Description
AES	Advanced Encryption Standard
CL	Contactless
CMAC	Cipher-based Message Authentication Code
DES	Digital Encryption Standard
ECC	Elliptic Curve Cryptography
ECDSA	Elliptic Curve Digital Signature Algorithm
ECDH	Elliptic Curve Diffie–Hellman
ECDHE	Elliptic Curve Diffie–Hellman ephemeral
ECDAA	Elliptic Curve Direct Anonymous Attestation
EdDSA	Edwards Curve Digital Signature Algorithm
HMAC	Keyed-Hash Message Authentication Code
I^2C	Inter-Integrated Circuit
IoT	Internet of Things
JCOP	Java Card Open Platform
KDF	Key Derivation Function
MAC	Message Authentication Code
NIST	National Institute for Standards and Technology
OEF	Order Entry Form
PSK	Pre-Share Key
RSA	Rivest-Shamir-Adleman
SCP	Secure Channel Protocol
SHA	Secure Hash Algorithm
TLS	Transport Layer Security
TPM	Trusted Platform Module

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1   Configuration Table

Table 1. SE050 configuration

		SE050C1	SE050C2	SE050B1	SE050B2	SE050A1	SE050A2	SE050ARD Dev Kit
ECC Crypto Schemes	ECDSA	x	x			x	x	x
	ECDH	x	x			x	x	x
	ECDHE	x	x			x	x	x
	ECDAA	x	x					x
	EdDSA	x	x					x
Supported Elliptic Curves	NIST (192 to 521 bit)	x	x			x	x	x
	Brainpool (160 to 512 bit)	x	x			x	x	x
	Koblitz (160 to 256 bit)	x	x			x	x	x
	Twisted Edwards/ Montgomery	x	x					x
RSA	RSA (up to 4096)	x	x	x	x			x
Symmetric Crypto Algorithm	3DES – 2K or 3K	x	x	x	x	x	x	x
	AES (128, 192, 256)	x	x	x	x	x	x	x
MAC	HMAC, CMAC	x	x	x	x	x	x	x
Hash Function	SHA-1, SHA-224, SHA-256, SHA-384, SHA-512	x	x	x	x	x	x	x
Key Derivation (KDF)	TLS KDF, TLS PSK	x	x	x	x	x	x	x
	MIFARE DESFire KDF	x	x					x
	Wi-Fi KDF (PBKDF2)	x	x	x	x	x	x	x
TPM Functionalities		x	x	x	x	x	x	x
Pre-Provisioned		x	x	x	x	x	x	x
Interfaces	I^{2}C Slave	x	x	x	x	x	x	x
	I^{2}C Master	x	x					x
	ISO14443 CL	x	x					x
Temperature range		-25 °C to +85 °C	-40 °C to +105 °C	-25 °C to +85 °C	-40 °C to +105 °C	-25 °C to +85 °C	-40 °C to +105 °C	-40 °C to +105 °C

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2 SE050 – pre-configuration for ease of use – Plug & Trust

2.1 General description

All SE050 variants are offered off-the-shelf pre-provisioned for ease of use. This means that for most of the use cases and cloud services customers are not required to program additional credentials. Device public cloud keys or IDs can be read out from the chip (e.g. at manufacturing time) and installed on different Cloud services depending on the respective Cloud authentication modalities. Additional information on the usage of the credentials can be found in several application notes on www.nxp.com. Also see APDU Specification, section 3.2.

2.2 Common keys

The keys below are present in all configurations.

For the value of the Platform SCP please refer to Table 3.

Table 2. Common keys

Key name	Details and type	Certificate	Erasable by customer	Identifier
Platform SCP	Default Value needed to perform update of the key	N/A	No	N/A
Fast SCP	IoT Applet Fast-SCP Authentication and Import Key, ECC256, Die Individual	IoT Applet Fast SCP Certificate (Signed by Attestation Certificate) for Authentication and Import	No	0x7FFF0201 (Authentication Key) 0x7FFF0202 (Import Key)

Table 3. Default Platform SCP keys

Configuration	ENC	MAC	DEK
SE050A1	34ae0967e329e9518e7265d5adcc01c2	52b253cadf472bdb3d0fb38e09770099	acc91431fe26811b5ecbc845620d8344
SE050A2	46a9c48c34efe344a522e66744f8996a	1203ff61dfbc9c86196a2274aef4ed28	f7561c6f48336119ee39439aab34098e
SE050B1	d499bc90dea542cf78d25e13d64cbb1f	0815559643fb79eb8501a0dc833d901f	be7ddfb406e81ae4e9665a9fed64267c
SE050B2	5fa43d8202d25e9a85b1fe7e2d26478d	105cea2219f52bd167a07463c69379c3	d7028157f2ad372c74be969bcc390627
SE050C1	852b5962e9cce5d0be746b833bcc6287	db0aa319a408696c8e107ab4e3c26b47	4c2f75c6a278a4aee5c9af7c50eea80c
SE050C2	bd1de20a81eab2bf3b709a9d69a31254	9a761b8dba6bedf22741e45d8d4236f5	9b993b600f1c64f5adc063192a96c947
Development Board	35c256458958a34f6136155f8209d6cd	af177d5dbdf7c0d5c10a05b9f1607f78	a1bc8438bf77935b361a4425fe79fa29

2.2.1 NXP reserved keys

Table 4. NXP reserved keys

Key name	Erasable by customer	Identifier
NXP reserved key 1	No	0x7FFF0204
NXP reserved key 2	No	0x7FFF0209
NXP reserved key 3	No	0xF0000030
NXP reserved key 4	No	0xF0000020

2.2.2 Variant fingerprint

The identifying information can be read out using the example "get info" from SE050 Plug&Trust MW package.

Table 5. Variant identifiers

Variant	Variant Identifier (OEF ID)
SE050A1	A204
SE050A2	A205
SE050B1	A202
SE050B2	A203
SE050C1	A200
SE050C2	A201
Development Board	A1F4

2.3 Variant A

Table 6. Variant A

Use case	Key name and type	Certificate	Usage policy (keys)	Erasable by customer (keys)[1]	Identifier
IoT Connectivity	Default Connectivity Key (Authentication Connectivity Key 0), ECC256, Die Individual	Connectivity Certificate 0	Anybody, Read	No	Key: 0xF0000000 Cert: 0xF0000001
IoT Connectivity	Default Connectivity Key (Authentication Connectivity Key 1), ECC256, Die Individual	Connectivity Certificate 1	Anybody, Read	No	Key: 0xF0000002 Cert: 0xF0000003
Attestation, proof of origin	Root of Trust signing key, ECC256, Die Individual (used to attest new generated keys)	N/A	Anybody Read and Attestation	No	Key: 0xF0000012

[1] Certificates are always erasable by customer

2.4 Variant B

Table 7. Variant B

Use case	Key name and type	Certificate	Usage policy (keys)	Erasable by customer (keys)[1]	Identifier
IoT Connectivity	Default Connectivity Key (Authentication Connectivity Key 0), RSA2048, Die Individual	Connectivity Certificate 0	Anybody, Read	No	Key: 0xF0000004 Cert: 0xF0000005
IoT Connectivity	Default Connectivity Key (Authentication Connectivity Key 1), RSA2048, Die Individual	Connectivity Certificate 1	Anybody, Read	No	Key: 0xF0000006 Cert: 0xF0000007
Attestation, proof of origin	Root of Trust signing key, RSA2048, Die Individual	N/A	Anybody, Read, and Attestation	No	Key: 0xF0000010

[1] Certificates are always erasable by customer

2.5 Variant C

Table 8. Variant C

Use case	Key name and type	Certificate	Usage policy (keys)	Erasable by customer (keys)[1]	Identifier
IoT Connectivity	Default Connectivity Key (Authentication Connectivity Key 0), ECC256, Die Individual	Connectivity Certificate 0, ECC signed	Anybody, Read	No	Key: 0xF0000000 Cert: 0xF0000001
	Default Connectivity Key (Authentication Connectivity Key 1), ECC256, Die Individual	Connectivity Certificate 1, ECC Signed	Anybody, Read	No	Key: 0xF0000002 Cert: 0xF0000003
Cloud Onboarding RSA	Cloud connection key 0, RSA2048, Die Individual	Cloud Connectivity Certificate 0, RSA Signed	Default	Yes	Key: 0xF0000110 Cert: 0xF0000111
	Cloud connection key 1, RSA2048, Die Individual	Cloud Connectivity Certificate 1, RSA Signed	Default	Yes	Key: 0xF0000112 Cert: 0xF0000113
Cloud Onboarding ECC	Cloud connection key 0, ECC256, Die Individual	Cloud Connectivity Certificate 0, ECC signed	Default	Yes	Key: 0xF0000100 Cert: 0xF0000101
	Cloud connection key 1, ECC256, Die Individual	Cloud Connectivity Certificate 1, ECC Signed	Default	Yes	Key: 0xF0000102 Cert: 0xF0000103
Attestation, proof of origin	Root of Trust signing key, ECC256, Die Individual (used to attest new generated keys)	Attestation Certificate, ECC Signed	Anybody Read and Attestation	No	Key: 0xF0000012 Cert: 0xF0000013

Use case	Key name and type	Certificate	Usage policy (keys)	Erasable by customer (keys)[1]	Identifier
	Root of Trust signing key, RSA2048, Die Individual (used to attest new generated keys)	Attestation Certificate, RSA Signed	Anybody Read and Attestation	No	Key: 0xF0000010 Cert: 0xF0000011
Cloud Onboarding RSA	RSA Key, RSA4096	Cloud Connectivity Certificate 0, RSA Signed	Default	Yes	Key: 0xF0000120 Cert: 0xF0000121
	RSA Key, RSA4096	Cloud Connectivity Certificate 1, RSA Signed	Default	Yes	Key: 0xF0000122 Cert: 0xF0000123

[1]   Certificates are always erasable by customer

2.6 SE050 Chain of trust certificates

2.6.1 Iot Connectivity

- SE050Ax
- SE050Bx

2.6.2 Cloud Onboarding RSA

- Root
  - Intermediate
    - SE050C1
    - SE050C2
    - Development Kit

2.6.3 Cloud Onboarding ECC

- Root
  - Intermediate
    - SE050C1
    - SE050C2
    - Development Kit

2.6.4 Attestation RSA

- Root
  - Intermediate

2.6.5 Attestation ECC

- Root
  - Intermediate

3   References

1. SE050 IoT Applet APDU Specification, document number AN 12413

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4   Legal information

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